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Docket No.: YPL-0310

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	Address: 416, Maetan-dong, Yeongtong-gu			
Additional names(s) of conveying party(ies)	113%			
3. Nature of conveyance:				
☐ Assignment ☐ Merger				
☐ Security Agreement ☐ Change of Name	City: Suwon-si State/Prov.: Gyeonggi-do			
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Execution Date: June 21,2006	Additional name(s) & address(es) □ Yes ☑ No			
4. Application number(s) or patent numbers(s):				
If this document is being filed together with a new application,	the execution date of the application is: June 21, 2006			
Patent Application No. Filing date	B. Patent No.(s)			
Additional numbers	☐ Yes ☒ No			
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:			
Name: Amy Bizon-Copp	7. Total fee (37 CFR 3.41):\$ 40.00			
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## **ASSIGNMENT**

WHEREAS We, [Nam Huh] of [3-402 Mujigae Apt., 1335 Seocho-dong, Seocho-gu, Seoul, Republic of Korea], and [Jeong-gun Lee] of [5-1001 Sampoong Apt., Seocho 4-dong, Seocho-gu, Seoul, Republic of Korea], (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

## [QUANTITATIVE CELL DISPENSING APPARATUS USING LIQUI D DROP MANIPULATION]

which claims priority to **[Korean]** Application No. <u>10-2005-0127795</u> filed on <u>22 December</u> <u>2005</u>, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, [Samsung Electronics Co., Ltd.] (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of [Republic of Korea], having a place of business at [416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea], is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications setup.

PATENT REEL: 018092 FRAME: 0294

RECORDED: 07/24/2006